

# NOT RECOMMENDED FOR NEW DESIGN USE DMP2040USS



DMP2038USS

#### 20V P-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

| BV <sub>DSS</sub> | R <sub>DS(ON)</sub> Max        | I <sub>D</sub> Max<br>T <sub>A</sub> = +25°C |
|-------------------|--------------------------------|--|
| -20V              | $38m\Omega @ V_{GS} = -4.5V$   | -6.5A  |
| -20V              | 56mΩ @ V <sub>GS</sub> = -2.5V | -5.0A  |

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

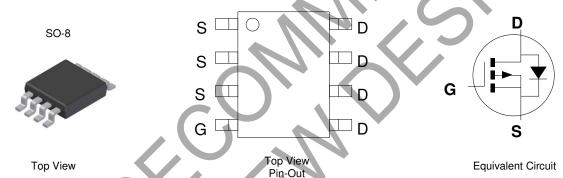
- Backlighting
- Power Management Functions
- DC-DC Converters

## **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.072g (Approximate)



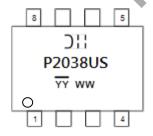
#### Ordering Information (Note 4)

| Part Number   | Case | Packaging        |
|---------------|------|------------------|
| DMP2038USS-13 | SO-8 | 2500/Tape & Reel |

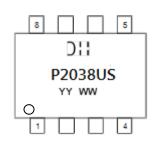
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

#### **Marking Information**



Chengdu A/T Site



Shanghai A/T Site

O|| = Manufacturer's Marking
P2038US = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Year (ex: 17 = 2017)
WW = Week (01 to 53)

 $\frac{YY}{YY}$  = Date Code Marking for SAT (Shanghai Assembly/ Test site)  $\overline{YY}$  = Date Code Marking for CAT (Chengdu Assembly/ Test site)



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## **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

| Characteristic                                     | Symbol                                       | Value          | Unit         |   |
|--|--|----------------|--------------|---|
| Drain-Source Voltage                               | $V_{DSS}$                                    | -20            | V            |   |
| Gate-Source Voltage                                | V <sub>GSS</sub>                             | ±8             | V            |   |
| Drain Current (Note 6) Steady State                | $T_A = +25^{\circ}C$<br>$T_A = +70^{\circ}C$ | I <sub>D</sub> | -6.5<br>-5.2 | А |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | I <sub>DM</sub>                              | -25            | А            |   |
| Maximum Continuous Body Diode Forward Current (No  | Is   | 2              | А            |   |
| Avalanche Current (Note 7) L=0.3mH                 | las  | 13.2           | Α            |   |
| Avalanche Energy (Note 7) L=0.3mH                  | Eas  | 26             | mJ           |   |

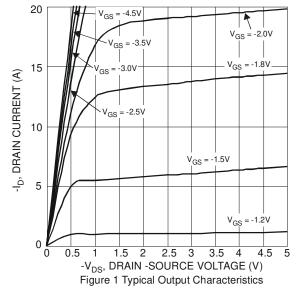
### **Thermal Characteristics**

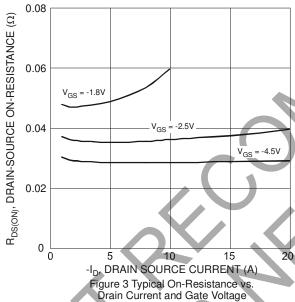
| Characteristic                                   | Symbol           | Value       | Unit |
|--|------------------|-------------|------|
| Total Power Dissipation (Note 6)                 | P <sub>D</sub>   | 2.5         | W    |
| Thermal Resistance, Junction to Ambient (Note 6) | $R_{	heta JA}$   | 50          | °C/W |
| Operating and Storage Temperature Range          | $T_{J}, T_{STG}$ | -55 to +150 | °C   |

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

|                                     |                     |          | _    |      |            |   |
|-------------------------------------|---------------------|----------|------|------|------------|---|
| Characteristic                      | Symbol              | Min      | Тур  | Max  | Unit       | Test Condition  |
| OFF CHARACTERISTICS (Note 8)        |                     |          |      |      |            |   |
| Drain-Source Breakdown Voltage      | BV <sub>DSS</sub>   | -20      |      |      | V          | $V_{GS} = 0V$ , $I_D = -250\mu A$   |
| Zero Gate Voltage Drain Current     | I <sub>DSS</sub>    |          |      | -1   | μΑ         | $V_{DS} = -16V, V_{GS} = 0V$  |
| Gate-Source Leakage                 | IGSS                |          | _    | ±100 | nA         | $V_{GS} = \pm 8V$ , $V_{DS} = 0V$   |
| ON CHARACTERISTICS (Note 8)         |                     |          |      |      |            |   |
| Gate Threshold Voltage              | V <sub>GS(TH)</sub> | -0.4     |      | -1.1 | V          | $V_{DS} = V_{GS}, I_D = -250 \mu A$   |
| Static Drain-Source On-Resistance   | Б                   |          | 24   | 38   | <b>m</b> O | $V_{GS} = -4.5V, I_D = -5A$   |
| Static Dialii-Source Oil-Nesistance | R <sub>DS(ON)</sub> |          | 33   | 56   | mΩ         | $V_{GS} = -2.5V$ , $I_D = -4.3A$  |
| Diode Forward Voltage               | $V_{SD}$            | <b>—</b> | -0.7 | -1.2 | V          | $V_{GS} = 0V$ , $I_S = -2.1A$   |
| DYNAMIC CHARACTERISTICS (Note 9)    |                     |          |      |      |            |   |
| Input Capacitance                   | C <sub>iss</sub>    |          | 1496 | _    | pF         | V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V<br>f = 1.0MHz  |
| Output Capacitance                  | Coss                | _        | 130  | _    | pF         |   |
| Reverse Transfer Capacitance        | Crss                | _        | 116  | _    | pF         |   |
| Total Gate Charge                   | Qg                  |          | 14.4 | _    |            | V <sub>DS</sub> = -10V, V <sub>GS</sub> = -4.5V<br>I <sub>D</sub> = -4.5A   |
| Gate-Source Charge                  | $Q_{gs}$            | _        | 2.6  | _    | nC         |   |
| Gate-Drain Charge                   | $Q_{gd}$            | _        | 2.7  | _    |            |   |
| Turn-On Delay Time                  | t <sub>D(ON)</sub>  | _        | 13.7 | _    |            | $\begin{aligned} V_{DD} &= \text{-}10\text{V},  V_{GS} = \text{-}4.5\text{V}, \\ R_g &= 6\Omega,  R_L = 10\Omega,  I_D = \text{-}1\text{A} \end{aligned}$ |
| Turn-On Rise Time                   | t <sub>R</sub>      | _        | 14.0 | _    | no         |   |
| Turn-Off Delay Time                 | t <sub>D(OFF)</sub> |          | 79.1 |      | ns         |   |
| Turn-Off Fall Time                  | t <sub>F</sub>      | _        | 35.5 | _    |            |   |

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- Device mounted on FR-4 FC board, with minimal recommended pad layout, Single stated.
   Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
   I<sub>AS</sub> and E<sub>AS</sub> ratings are based on low frequency and duty cycles to keep T<sub>J</sub> = +25°C.
   Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to product testing.





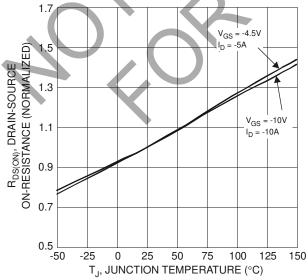
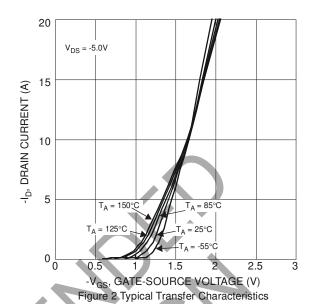
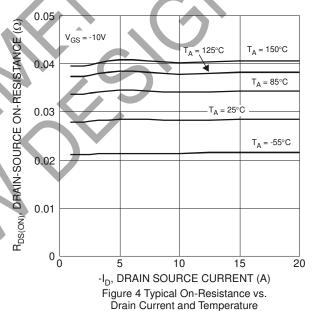


Figure 5 On-Resistance Variation with Temperature





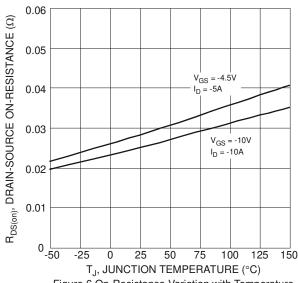


Figure 6 On-Resistance Variation with Temperature

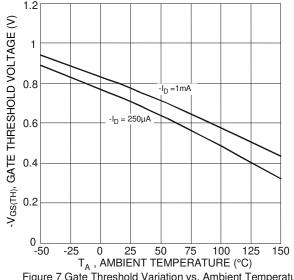
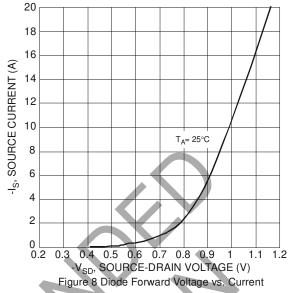
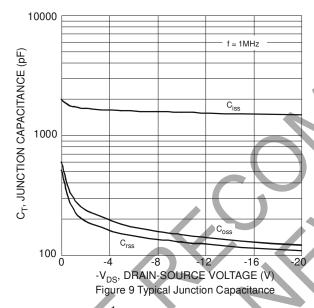
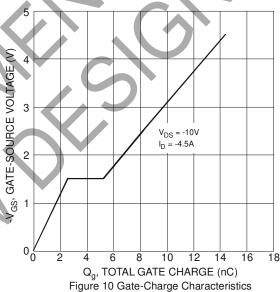
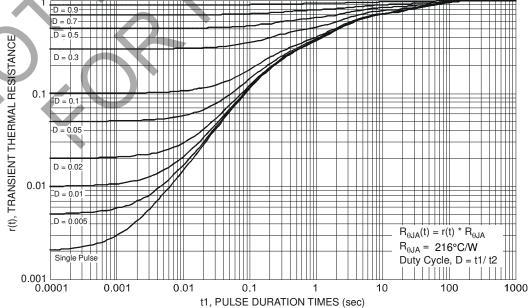


Figure 7 Gate Threshold Variation vs. Ambient Temperature







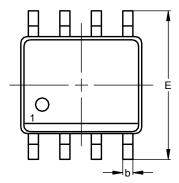


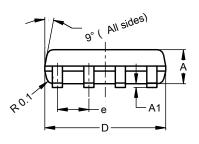


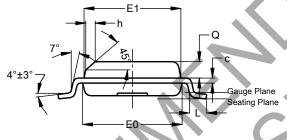
## **Package Outline Dimensions**

 $Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$ 

SO-8



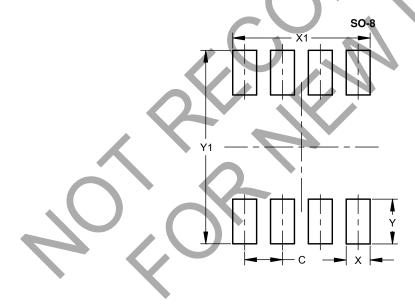




| SO-8                 |      |      |      |  |
|----------------------|------|------|------|--|
| Dim                  | Min  | Max  | Тур  |  |
| Α                    | 1.40 | 1.50 | 1.45 |  |
| A1                   | 0.10 | 0.20 | 0.15 |  |
| b                    | 0.30 | 0.50 | 0.40 |  |
| O                    | 0.15 | 0.25 | 0.20 |  |
| D                    | 4.85 | 4.95 | 4.90 |  |
| Е                    | 5.90 | 6.10 | 6.00 |  |
| E1                   | 3.80 | 3.90 | 3.85 |  |
| E0                   | 3.85 | 3.95 | 3.90 |  |
| е                    |      | -    | 1.27 |  |
| 7                    |      |      | 0.35 |  |
| 7                    | 0.62 | 0.82 | 0.72 |  |
| Ď                    | 0.60 | 0.70 | 0.65 |  |
| All Dimensions in mm |      |      |      |  |

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С          | 1.27          |
| Х          | 0.802         |
| X1         | 4.612         |
| Υ          | 1.505         |
| Y1         | 6.50          |



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